



Fast Recovery Surface Mount Rectifier Reverse Voltage 1000 Volts Forward Current 3.0 Amperes

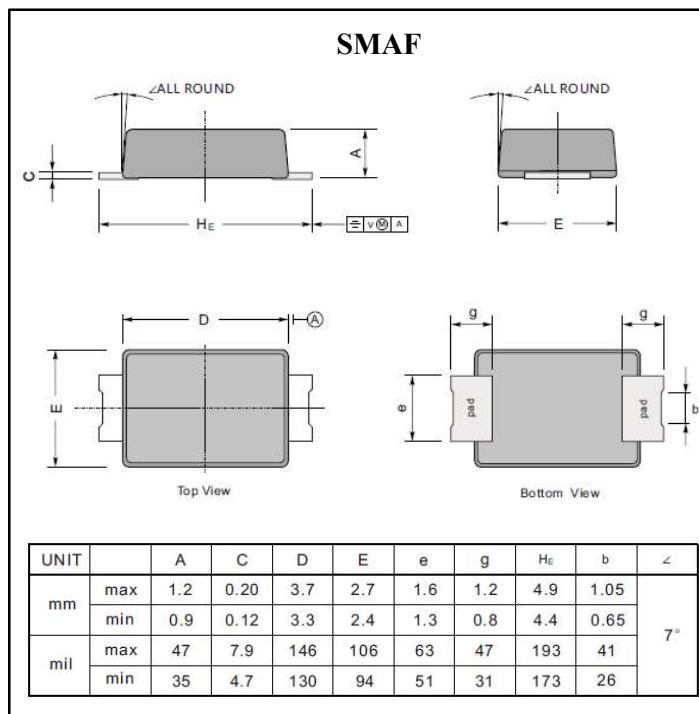
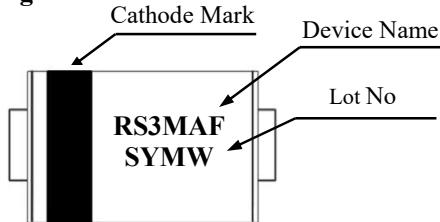
Features

- For surface mounted application
- Glass passivated junction chip
- Fast switching for high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

Mechanical Data

- Case : SMAF
- Terminals : Solderable per MIL-STD-750, Method 2026
- Polarity : Color band denotes cathode end
- Approx. Weight : 0.027gram

Marking



Maximum Ratings & Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified

Single phase half wave 60 HZ, resistive or inductive load

For capacitive load, derate current by 20%

Parameter	Symbol	Rated Value		Unit	Remark
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	1000		V	
Maximum RMS Voltage	V _{RMS}	700		V	
Maximum DC Blocking Voltage	V _{DC}	1000		V	
Maximum Average Forward Rectified Current See Fig.1	I _{F(AV)}	3.0		A	
Peak Forward Surge Current 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	80		A	
Maximum Instantaneous Forward Voltage at 3.0A	V _F	1.3		V	
Maximum DC Reverse Current at Rated DC Blocking Voltage	I _R	5		uA	T _a =25°C
		150		uA	T _a =125 °C
Maximum Reverse Recovery Time	trr	160		ns	Note 1
Typical Junction Capacitance	C _J	60		pF	Note 2
Typical Thermal Resistance	R _{th(j-a)}	60		°C/W	Note 3
	R _{th(j-l)}	15		°C/W	
Operation Junction Temperature Range	T _J	-55 to +150		°C	
Storage Temperature Range	T _{STG}	-55 to +150		°C	

Note 1. Reverse Recovery Test Conditions : I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 2. Measured at 1MHz and applied reverse voltage of 4.0 volts

Note 3. Mounted on glass epoxy PC board with 4×1.0"×1.0" (2.54 × 2.54 cm) copper pad.



Ratings and Characteristics Curves (Ta=25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

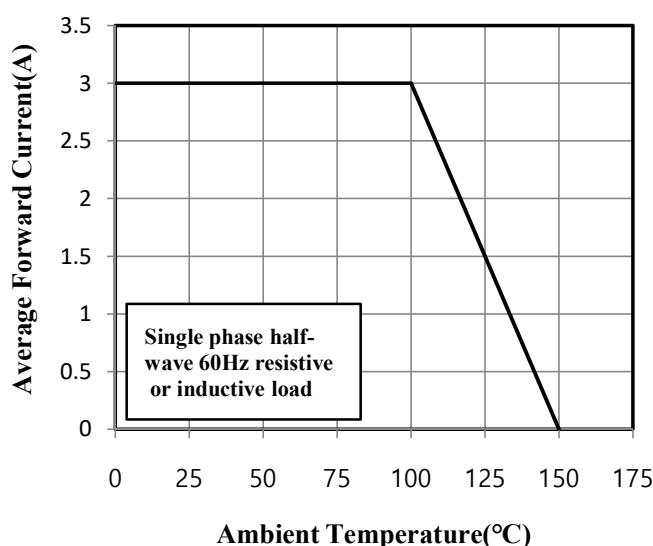


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

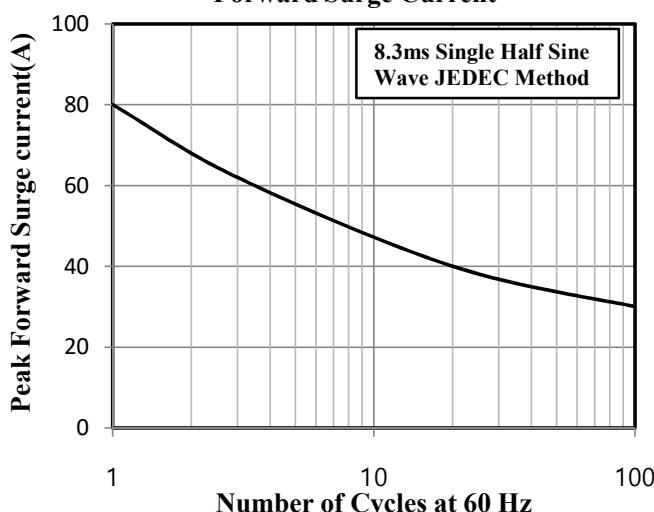


Fig.3 Typical Instantaneous Forward Characteristics

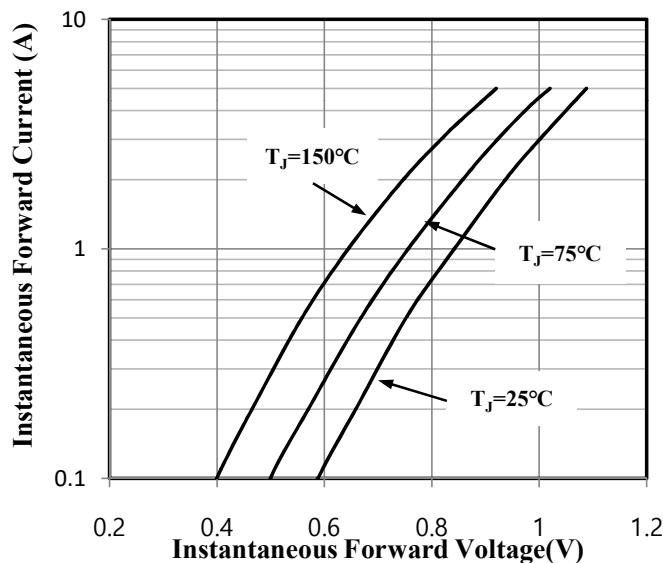


Fig.4 Typical Junction Capacitance

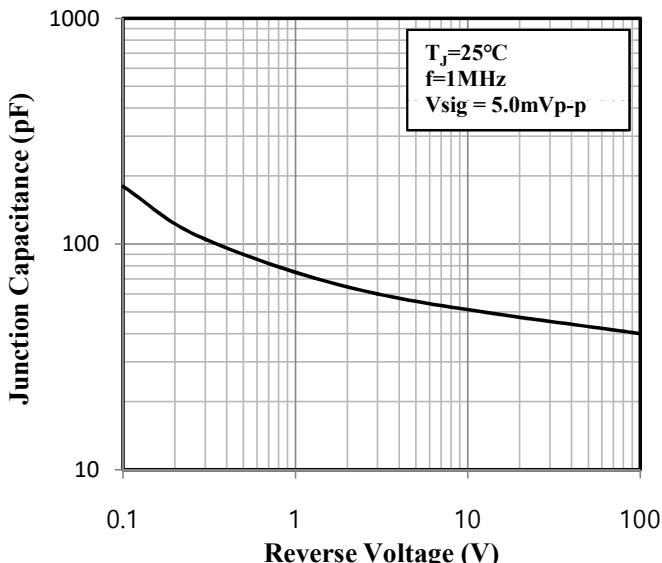


Fig.5 Typical Reverse Characteristics

